

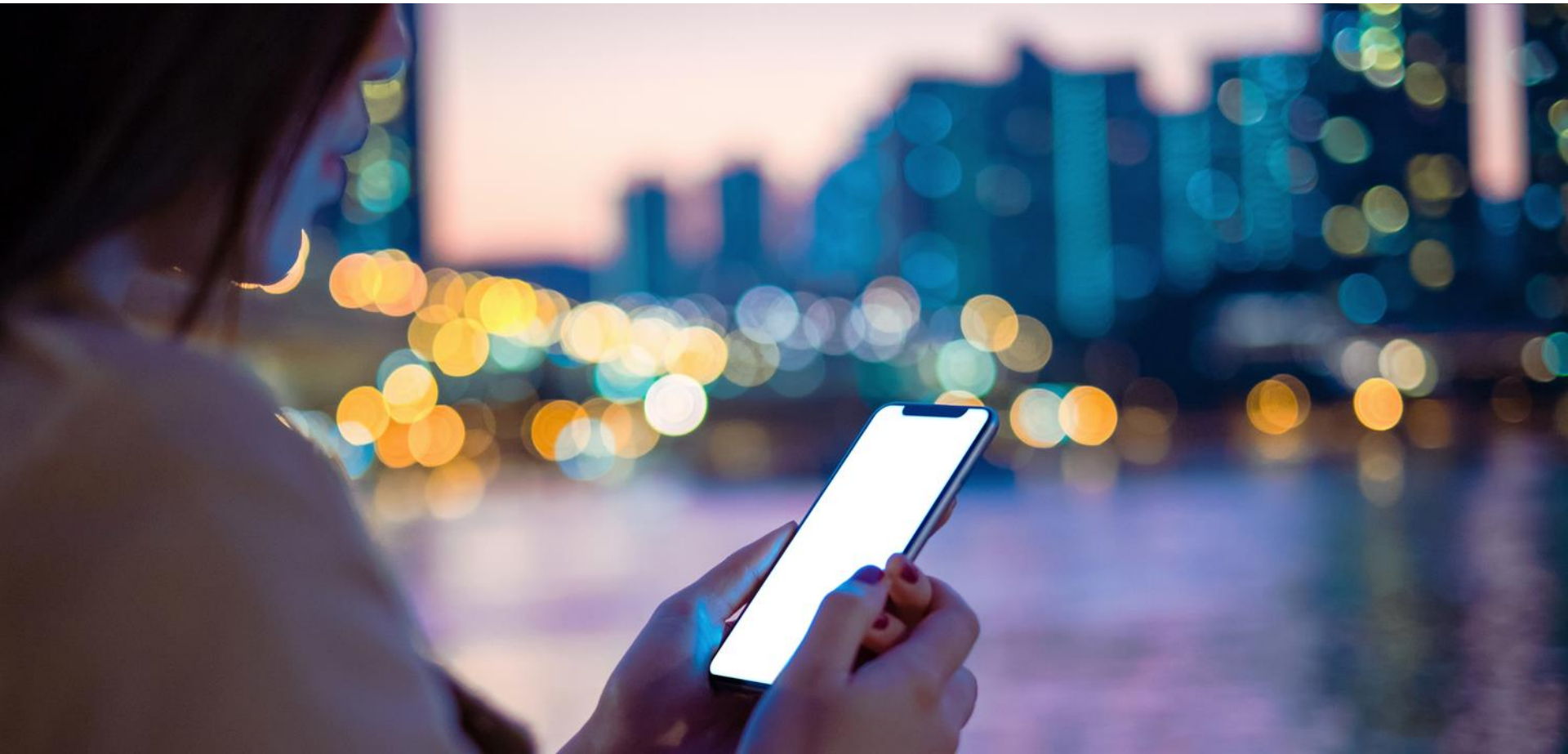
Edge AI Smart Sensor Systems



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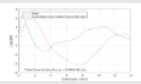


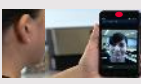







How do we want to interact with machines in future?



Infineon's consumer sensors: We focus on MEMS sensors and target to become the leader in 3D sensing and radar



Microphone	Pressure	Environmental	3D radar	3D ToF
 no distortions	 best-in-class resolution	 world smallest form factor 6x6mm ²	 highest energy efficiency	 best-in-class resolution
 receive clear audio signals	 measure height	 measure CO ₂	 biometrics	 3D mapping



Smart Ears, Smart Feeling, Smart Nose

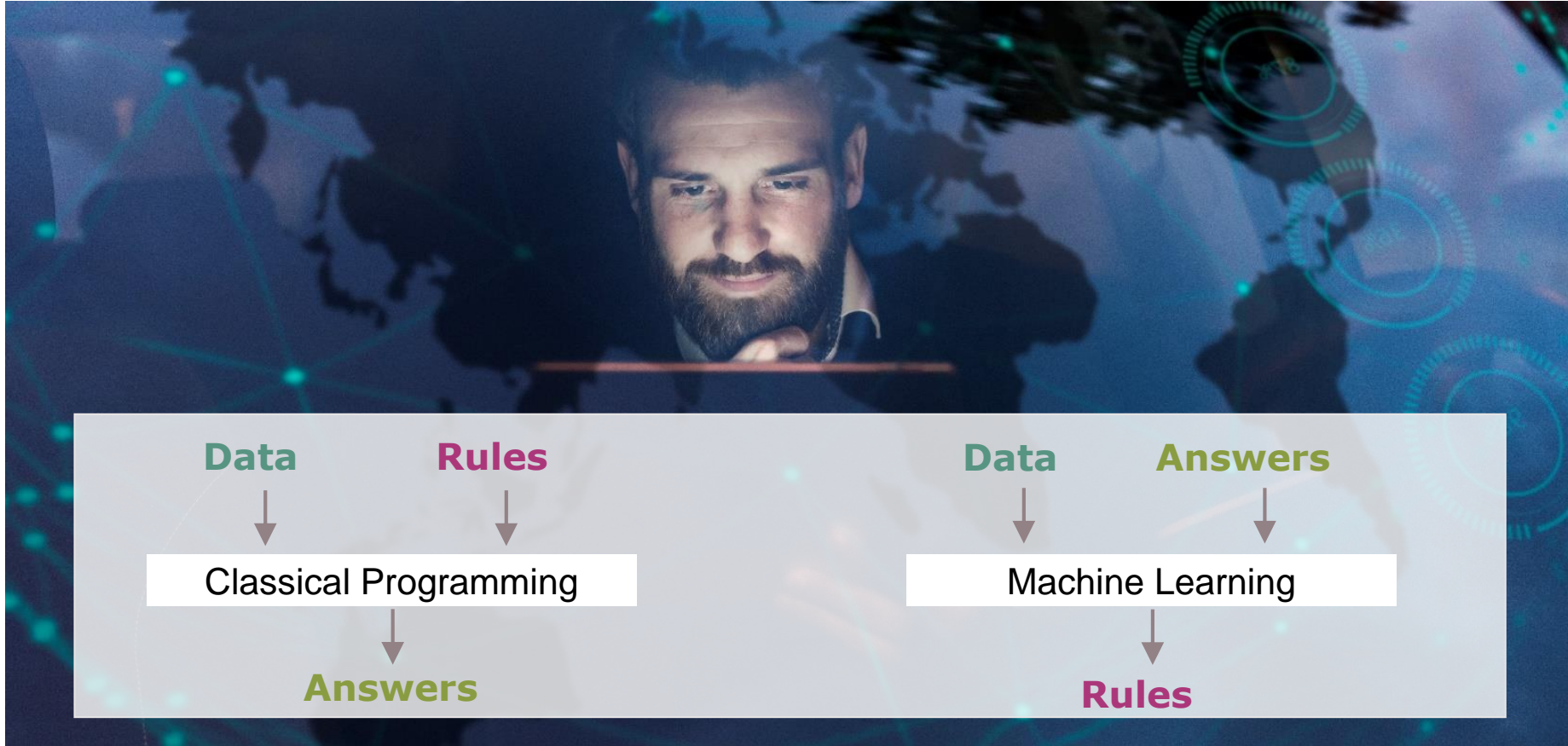


Smart Eyes & Sixth Sense

Use Cases Examples				
Voice authentication	Advanced fitness tracking	Smog alarm	Gesture sensing	3D AR gaming
			Face recognition & biometric identification	
Human Machine Interface				

Machine Learning:

Systems learn from data and recognize patterns



AI chips make it possible to develop edge-AI applications

General Purpose Processor



- › Application-specific functionality via software
- › One fits it all
- › Disadvantage: for nothing optimal

AI Accelerator

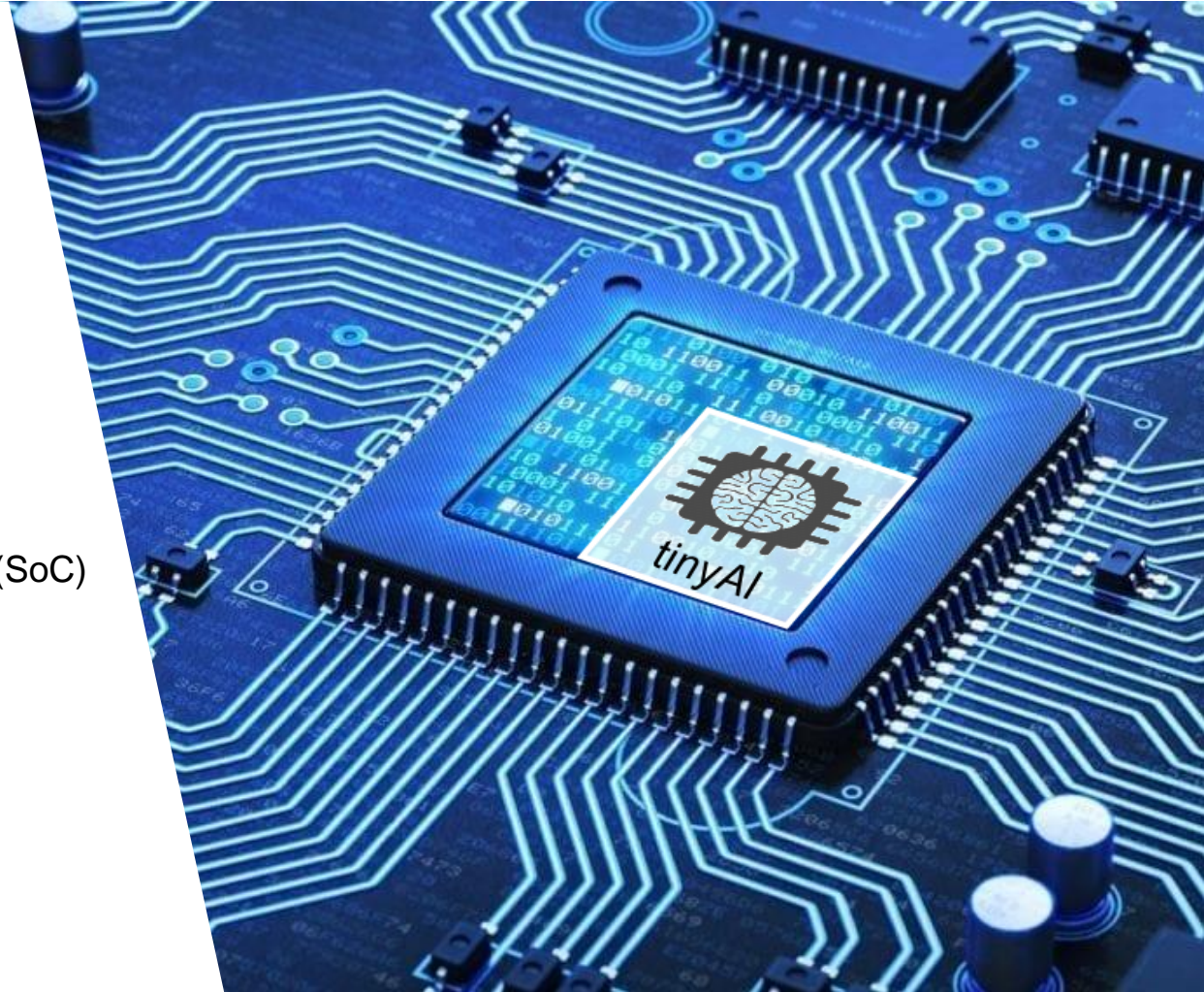
(Application Specific Instruction Processor)



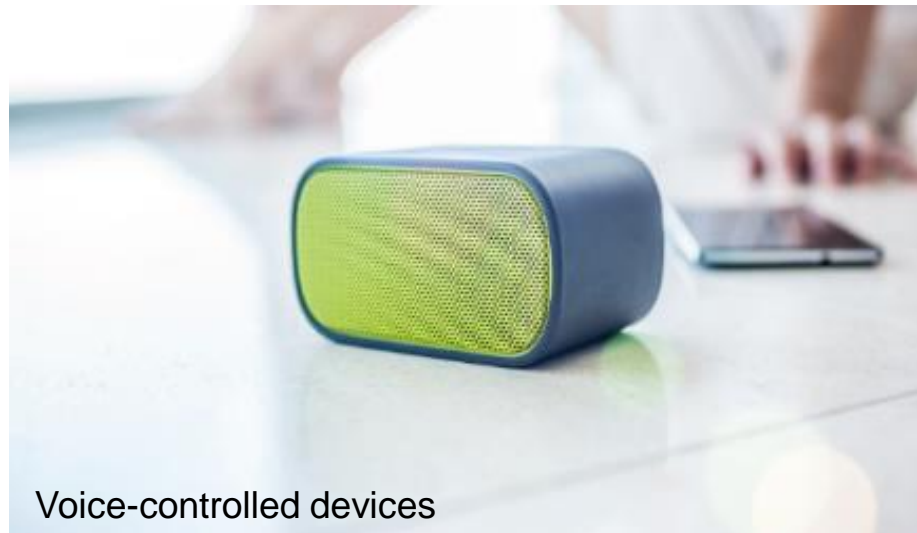
- › Optimized for one application: ML
- › New Hardware Architectures
- › Advantage: optimal performance, high energy efficiency

tinyAI is the Infineon Intellectual Property (IP) project for AI acceleration at the edge

- › AI algorithms are accelerated in tinyAI IP block on System on Chip (SoC)
- › tinyAI is an Application Specific Instruction Processor (ASIP)
- › tinyAI enables ultra-low power AI acceleration for always-on applications e.g. keyword spotting



Intuitive sensing for natural interactions with the digital world



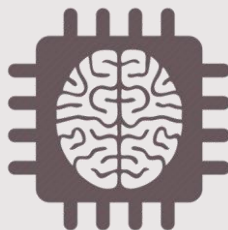
Voice-controlled devices



Gesture control



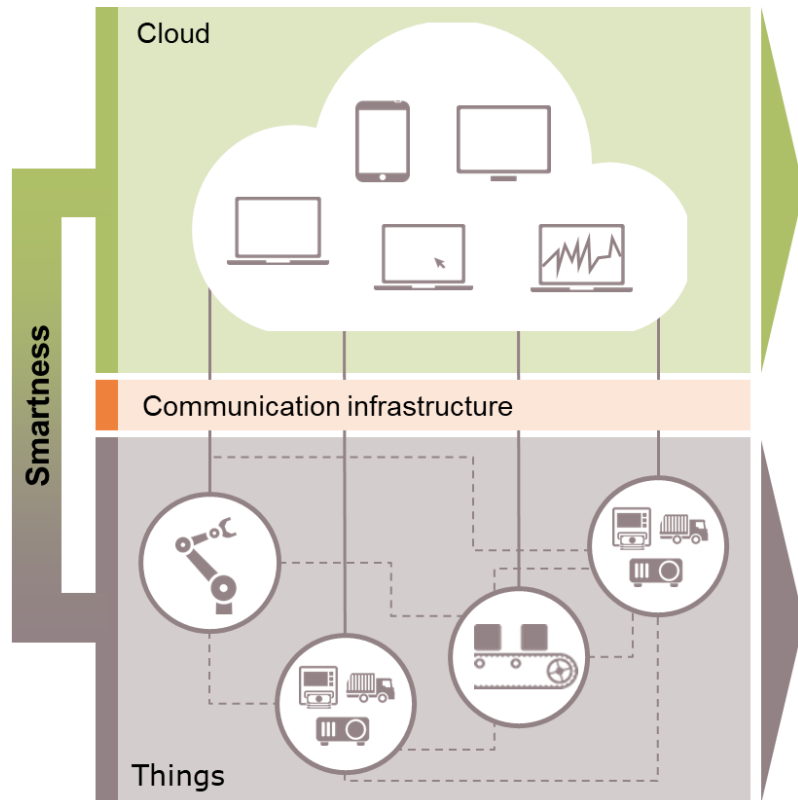
New Sensors



Edge AI

= Smart Sensors

It's the intelligent devices that make the IoT "smart"



Top layer of "IoT smartness"

- > At cloud level, the information of individual intelligent devices is aggregated
- > A range of applications process the available information according to defined use cases

Basic layer of "IoT smartness"

- > Intelligent devices are equipped with sensors, processors, security and actuators
- > Thus, they can collect data, coordinate and analyze it, secure it, and initiate actions

Machine Learning

Training

of ML models
on big data

Edge AI Inference

real time
low power

Edge-AI chips for smart sensor systems



AI chips are necessary to enable edge-AI applications.

Advantages of Edge AI:

- › Low latency
- › Energy efficiency
- › Data security

Infineon's first Edge AI chip is developed in Dresden.

DC Dresden: ready for edge-AI success stories



- › Almost 50 employees
 - Automotive electronics for embedded power and e-mobility applications
 - Chip design and functional verification
 - Smart chips with embedded AI
- › Long-term vision: 250 people
- › State-of-the-art labs

Strong ecosystem for AI hardware made in Germany





Part of your life. Part of tomorrow.